

# SAMPLE APPROVAL SHEET

#### **DESCRIPTIONS:**

- •1.0x0.5x0.48mm SMD LED
- •Emitting Color:White
- •Lens Color:Yellow Fluorescent

CUSTOM	[ER:
MASON	P/N: <u>KGK1005-T1D/S530-A4/3T</u>
CUSTOM	ER P/N:

## **CUSTOMER APPROVED SIGNATURES**

APPROVRD BY	CHECKED BY
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#### PRELIMINARY SPEC

1.0x0.5X0.48mm SMD CHIP LED

PART NO: 0402 白灯



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
LECTROSTATIC DISCHARGE
SENSITIVE DEVICES

#### **Features**

- 1.0mmx0.4mm SMT LED, 0.48mm THICKNESS.
- SIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- PACKAGE: 5000PCS/REEL.
- RoHS COMPLIANT.

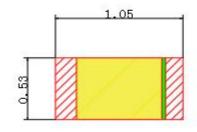
#### **Applications**

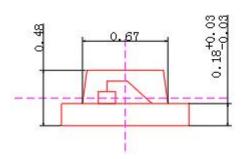
Automotive: backlighting in dashboard and switch.

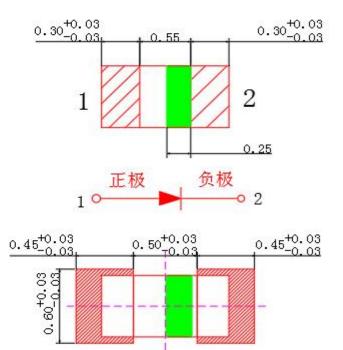
• Telecommunication: indicator and back-lighting in telephone and fax.

• Flat backlight for LCD switch and symbol.

### ◆ Package Dimensions







Notes:



- 1. All dimensions are in millimeters.
- 2. Tolerance is  $\pm 0.1$ mm unless otherwise noted.
- 3. Specifications are subject to change without notice.

#### **Device Selection Guide**

Part No.	Cl	Lens color	
0402白灯	Material	Emitted color	Yellow Fluorescent
	(InGaN)	WHITE	1 ellow 1 luorescent

#### Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	Value	Unit	
Power Dissipation	PD	100	mW	
Forward Current	IF	20	mA	
Peak Forward Current*1	IFP	100	mA	
Reverse Voltage	VR	5	V	
Operating Temperature	Topr	-40°C To +85°C		
Storage Temperature	Tstg	-40°C T	o +85°C	

#### ◆ Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Min	typ	Max	Unit	Test Conditions	
Forward Voltage	VF	2.6	_	3.2	V	IF=5mA	
Reverse Current	IR	_	_	10	μA	VR=5V	
Chromaticity Coordinates	Х	_	0.27	_		IF=5mA	
Chromaticity Coordinates	Y	_	0.28	_		IF-SITIA	
Luminous Intensity	IV	130	_	320	mcd	IF=5mA	
Viewing Angle	201/2	_	120	_	Deg.	IF=5mA	

#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or chromaticity), the typical accuracy of the sorting process is as follows:

- 1. Chromaticity Coordinates: ±0.01
- 2. Luminous Intensity: ±15%

Notes: \*1: Pulse width≤0.1ms, Duty cycle≤1/10



#### 3. Forward Voltage: ±0.1V

### ◆ Typical Electrical/Optical Characteristics Curves

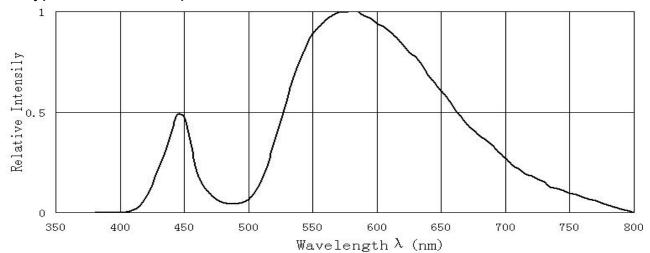
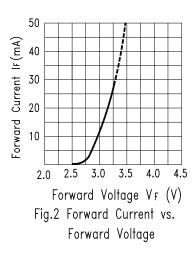
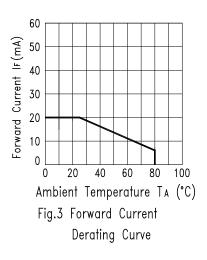


Fig. 1 Relative Intensity vs. Wavelength





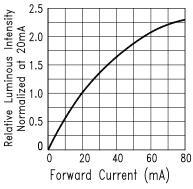


Fig.4 Relative Luminous Intensity vs. Forward Current

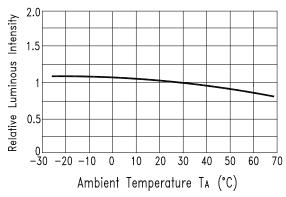


Fig.5 Luminous Intensity vs.Ambient Temperature

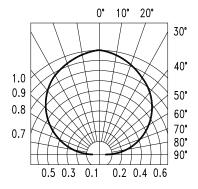
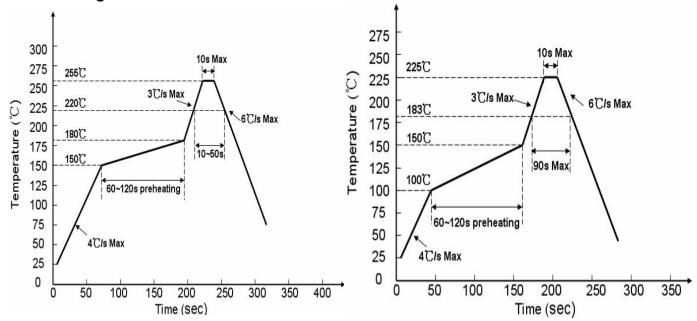


Fig.6 Spatial Distribution



# ◆ Soldering Profile

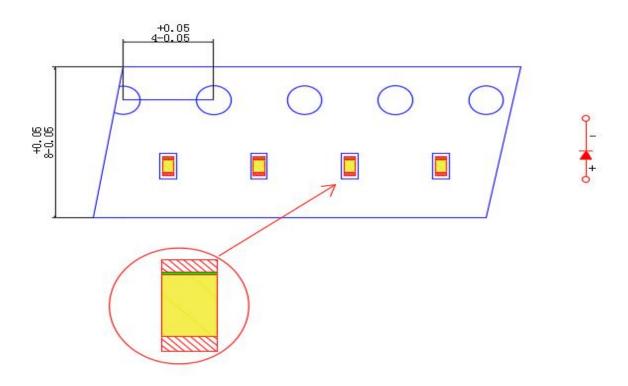


Free Lead process

Lead process

# Tape specifications

(Units:mm)





# ◆ VF Rank

Rank		V	Condition	
		MIN MAX		
	b2	2.6	2.7	
b C	b3	2.7	2.8	
	b4	2.8	2.9	IΓ=5~Λ
	b5	2.9	3.0	IF=5mA
	c1	3.0	3.1	
	c2			

Tolerance:±0.05V

# ◆ IV Rank

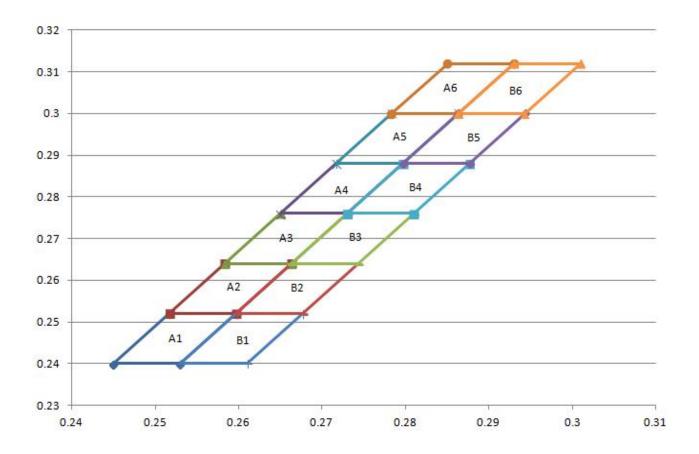
Rank		ין	Condition	
		MIN	MAX	Condition
0	01	130	0 170	
О	O2	170	220	IΓ=5~Λ
р	p1	220	270	IF=5mA
	p2	270	320	

Tolerance:±15%

# KGKLIGHT

# ◆ X Y Rank

	X1Y1	X1Y2	ХЗҮЗ	X4Y4		X1Y1	X1Y2	ХЗҮЗ	X4Y4
Λ 1	0. 245	0. 2517	0. 2597	0. 253	D1	0. 253	0. 2597	0. 2677	0. 261
A1	0. 24	0. 252	0. 252	0. 24	B1	0. 24	0. 252	0. 252	0. 24
10	0. 2517	0. 2583	0. 2663	0. 2597	DO.	0. 2597	0. 2663	0. 2743	0. 2677
A2	0. 252	0. 264	0. 264	0. 252	B2	0. 252	0. 264	0. 264	0. 252
A3	0. 2583	0. 265	0. 273	0. 2663	DO	0. 2663	0. 273	0. 281	0. 2743
AS	0. 264	0. 276	0. 276	0. 264	В3	0. 264	0. 276	0. 276	0. 264
A4	0. 265	0. 2717	0. 2797	0. 273	B4	0. 273	0. 2797	0. 2877	0. 281
A4	0. 276	0. 288	0. 288	0. 276		0. 276	0. 288	0. 288	0. 276
A5	0. 2717	0. 2783	0. 2863	0. 2797	DE	0. 2797	0. 2863	0. 2943	0. 2877
AS	0. 288	0.3	0.3	0. 288	В5	0. 288	0.3	0.3	0. 288
A6	0. 2783	0. 285	0. 293	0. 2863	В6	0. 2863	0. 293	0. 301	0. 2943
АО	0.3	0. 312	0.312	0.3	סט	0.3	0.312	0. 312	0.3



Tolerance:±0.005



#### ◆ CAUTIONS:

#### 1.Storage

- In order to avoid the absorption of moisture, it is recommended to store in the dry box (or desicca tor) with a desiccant. Otherwise, to store them in the following environment is recommended. Temperature: 5°C~30°CHumidity: 60%HR max.
- Attention after opened

However LED is corresponded SMD, when LED be soldered dip, interfacial separation may affect The light transmission efficiency, causing the light intensity to drop. Attention in followed. a. After opened and mounted, the soldering shall be quickly. b. Keeping of a fraction Temperature: 5°C~40°C Humidity: less than 30%

- In case or more than 1 week passed after opening or change color of indicator on desiccant compo nents shall be dried 10-12hr. at 60°C±3°C.
- In case of supposed the components is humid, shall not be dried dip-solder just before. 100Hr at 80°C±3°C or 12Hr at 100°C±3°C

#### 2.ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

The following procedures may decrease the possibility of ESD damage.

- All production machinery and test instruments must be electrically grounded.
- Use a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- Maintain a humidity level of 50% or higher in production areas.
- Use anti-static packaging for transport and storage.
- 3.Please be careful when using in an environment with high concentrations of sulphur or sulphuric gases, as sulphuration can lead to disconnection from the chip resistor or a poor contact connection.